Z21  ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

Z22  ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

Z23  ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Z24  ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

<p>| TABLE 1 |</p>
<table>
<thead>
<tr>
<th>Variant</th>
<th>Label text</th>
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<tr>
<td>D01</td>
<td>bq102400UV</td>
</tr>
<tr>
<td>D02</td>
<td></td>
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</tbody>
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COMPONENTS MARKED ‘DNP’ SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: D01

PCB VIEWED FROM TOP SIDE  | BOARD #: PWR578  | REV: A  | SUN REV: Not In VersionControl
---|-----------------|--------|------------------|
IGNORE ->                   |                  |        |                  |

PLOT NAME = Top Assembly Drawing  | GENERATED : 11/7/2014 1:08:50 PM  | TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: PWR578</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td>IGNORE</td>
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| PLOT NAME = Bottom Assembly Drawing | GENERATED : 11/7/2014 1:08:50 PM | TEXAS INSTRUMENTS |
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